

Tool ID: 306
Tool Location: 110

Equipment Information Sheet AJA Sputter Deposition

Manager: Tom Pennell
Backup: Mac McMurdy

607-254-4309
607-254-4813

Calls to staff phones will be automatically forwarded to their cell phones during accessible hours. At other times leave a message or send them an email.

SAFETY

- No unusual hazards during normal operation

USAGE RESTRICTIONS

- No buddy system restrictions

SCHEDULING/SIGN-UP RESTRICTIONS

- Maximum 4 hr block reservations anytime
- Must leave a 4hr block between reservations
- Maximum 12 hours reserved in advance at any time

Minimum Tool Time: 30 minutes

MATERIALS COMPATIBILITY CATEGORY

Tool Category 4: Glass and Metal Categories

Allowed	Not Allowed
Tool category 1/1E, 2, and 3 materials	
Silicon Based Substrates and Films	No CNF Class A metals
III/V compound Semiconductors	No Exposed CNF Group B metals- <i>metals can be buried/covered with staff approval</i>
Glass Substrates	Cannot be used as an etch stop
PECVD and ALD Films	
Buried Class B Metals with approval	
Organic/Bio Materials prepped w/o Salt Buffers	
Cured organics and baked Photoresist	No High Vapor pressure materials

High Vapor Pressure Metals and Compounds are materials that have a vapor pressure above 1e-6 Torr at 400 C.

Additional Material Restrictions and Exceptions

- No high vapor pressure substrates or films (Lead, Zinc, Indium, ITO, Tin, Cadmium, etc)

Last Updated: 10/27/2021